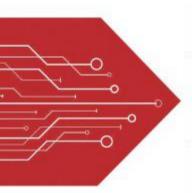
MSKSEMI SEMICONDUCTOR















ESD

TVS

TSS

MOV

GDT

PLED

Product data sheet



Compiance

Description

The MSK100N03DF uses advanced trench technology

to provide excellent RDS(ON), low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = 30V I_D =100A

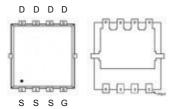
 $R_{DS(ON)}$ < 4 m Ω @ Vgs=10V

Application

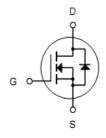
Battery protection

Load switch

Uninterruptible power supply



DFN3X3-8L



N-Channel MOSFET

Absolute Maximum Ratings (TC=25°C unless otherwise specified)

Symbol	Parameter	Rating	Units
Vps	Drain-Source Voltage	30	V
Vgs	Gate-Source Voltage	±20	V
Ib@Tc=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	100	Α
Ib@Tc=100°C	Continuous Drain Current, V _{GS} @ 10V ¹	70	Α
Io@Ta=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	30	Α
Io@Ta=70°C	Continuous Drain Current, V _{GS} @ 10V ¹	25	Α
Ірм	Pulsed Drain Current ²	192	Α
EAS	Single Pulse Avalanche Energy ³	144.7	mJ
las	Avalanche Current	53.8	Α
Pb@Tc=25°C	Total Power Dissipation4	62.5	W
Pd@Ta=25°C	Total Power Dissipation4	4.5	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Reja	Thermal Resistance Junction-ambient ¹	62	°C/W
Reuc	Thermal Resistance Junction-Case ¹	2.4	°C/W

Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVpss	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
ΔBV _{DSS} /ΔT _J	BVDSS Temperature Coefficient	Reference to 25°C , ID=1mA		0.0213		V/°C
		Vgs=10V , Ip=30A		3.4	4	
RDS(ON)	Static Drain-Source On- Resistance ²	V _{GS} =4.5V , I _D =15A		5.2	6	mΩ
V _{GS} (th)	Gate Threshold Voltage		1.0		2.5	V
$\Delta V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	Vgs=Vds , ld =250uA		-5.8		mV/°C
lpec	Drain Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	
loss	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55°C			5	uA
lgss	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
gfs	Forward Transconductance	VDS=5V , ID=30A		26.5		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.4		Ω
Q_g	Total Gate Charge (4.5V)			31.6		
Qgs	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V ,		8.6		nC
Qgd	Gate-Drain Charge	ID=15A		11.7		
Td(on)	Turn-On Delay Time			9		
Tr	Rise Time	V _{DD} =15V , V _{GS} =10V , R _G =3.3 Ω		19		
T _{d(off)}	Turn-Off Delay Time			58		ns
Tf	Fall Time	ID=15A		15.2		
Ciss	Input Capacitance			3075		
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V ,		400		pF
Crss	Reverse Transfer Capacitance	f=1MHz		315		•
Is	Continuous Source Current _{1,6}	V _G =V _D =0V , Force			100	Α
Ism	Pulsed Source Current _{2,6}				192	Α
Vsp	Diode Forward Voltage ²	V _G s=0V , I _S =1A , T _J =25°C			1	V

Diode Characteristics

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300 us$, duty cycle $\leq 2\%$
- $3\,$.The EAS data shows Max. rating . The test condition is V_DD=25V,V_GS=10V,L=0.1mH,I_AS=34A 4.The power dissipation is limited by 150°C junction temperature
- 5 .The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

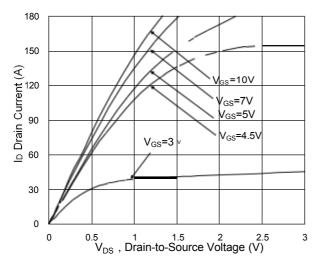


Fig.1 Typical Output Characteristics

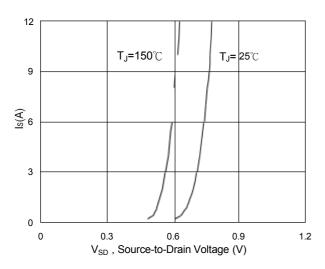


Fig.3 Forward Characteristics of Reverse

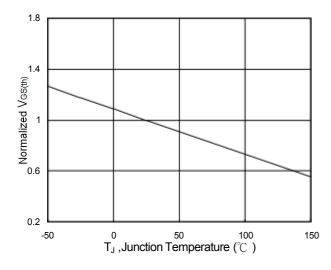


Fig.5 Normalized V_{GS(th)} vs. T_J

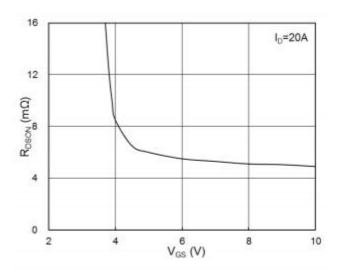


Fig.2 On-Resistance vs. G-S Voltage

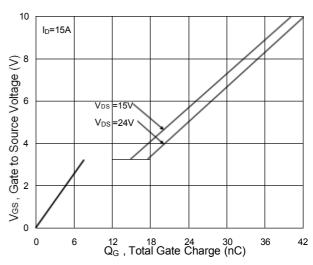


Fig.4 Gate-Charge Characteristics

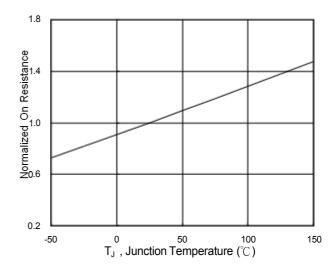
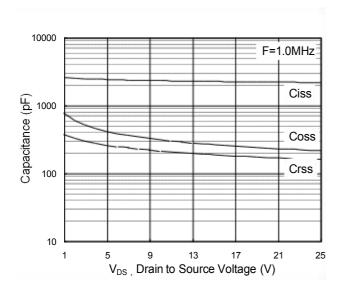


Fig.6 Normalized RDSON vs. TJ





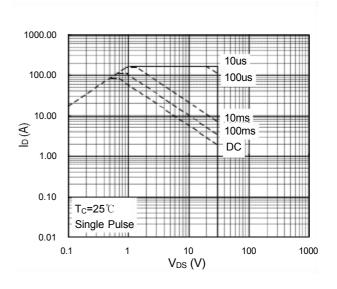


Fig.7 Capacitance

Fig.8 Safe Operating Area

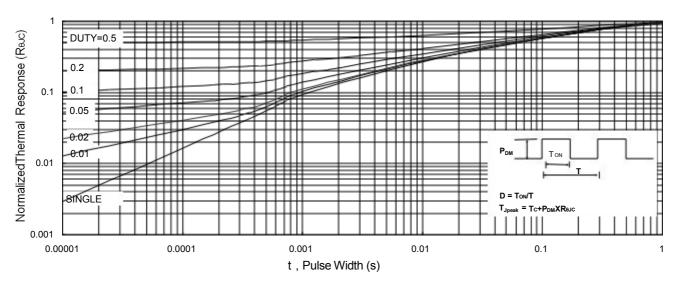


Fig.9 Normalized Maximum Transient Thermal Impedance

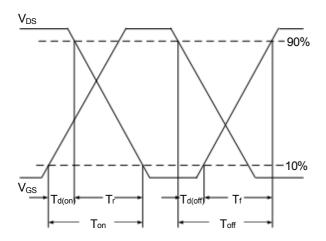


Fig.10 Switching Time Waveform

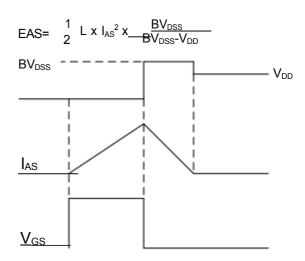
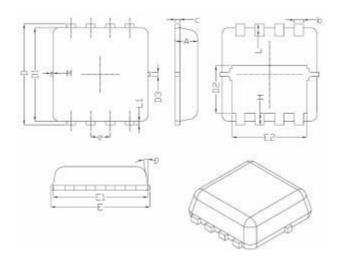


Fig.11 Unclamped Inductive Switching Waveform

Compiance

DFN3X3-8L Package Information



O	Dimensions In Millimeters		
Symbol	Min.	Nom.	Max.
A	0.70	0.75	0.80
b	0.25	0.30	0.35
С	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.48	1.58	1.68
D3	-	0.13	-
E	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
е		0.65BSC	
Н	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	-	0.13	-
М	*	*	0.15
θ		10 °	12 [°]

REEL SPECIFICATION

P/N	PKG	QTY
MSK100N03DF	DFN3X3-8L	5000



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C3M0021120D DMN13M9UCA6-7 BSS340NWH6327XTSA1 MCM3400A-TP DMTH10H4M6SPS-13 IRF40SC240ARMA1
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